
2SJ363

Silicon P-Channel MOS FET

HITACHI

November 1996

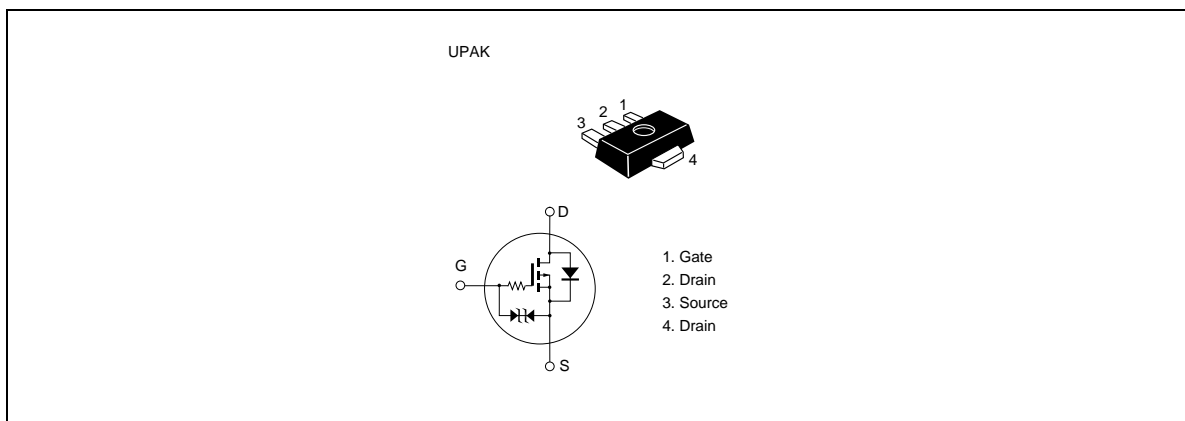
Application

Low frequency power switching

Features

- Low on-resistance
- Low drive current
- 4 V gate drive device can be driven from 5 V source

Outline



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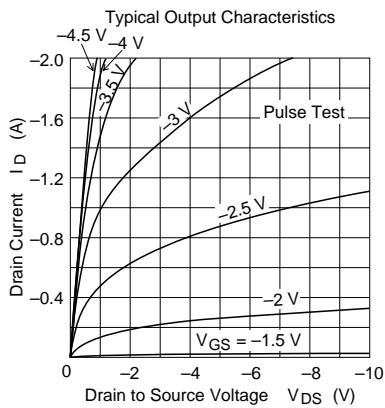
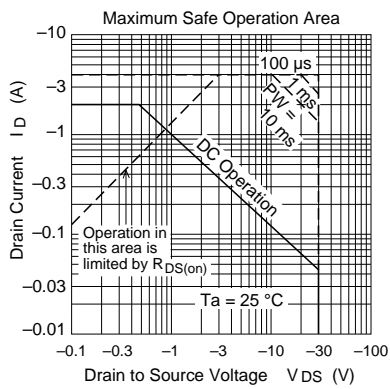
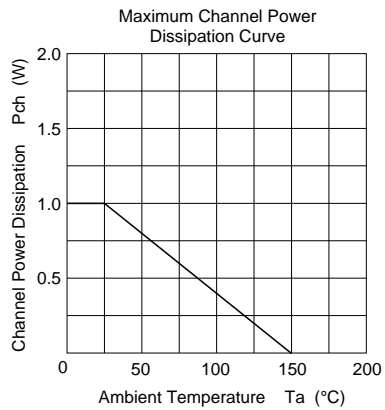
Absolute Maximum Ratings (Ta = 25°C)

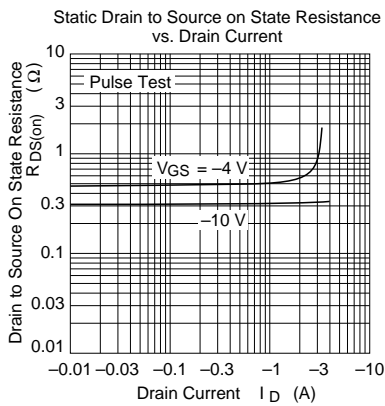
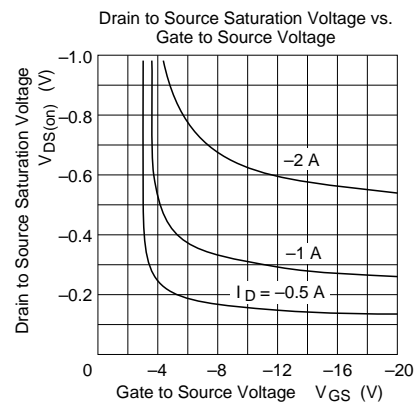
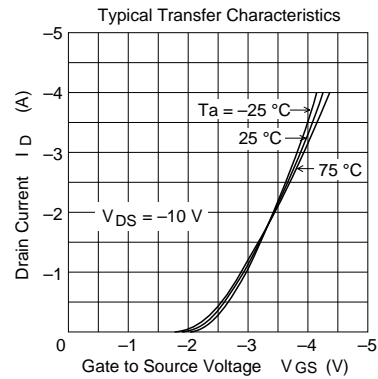
Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DS}	-30	V
Gate to source voltage	V_{GS}	±20	V
Drain current	I_D	-2	A
Drain peak current	$I_{D(pulse)}^{*1}$	-4	A
Body to drain diode reverse drain current	I_{DR}	-2	A
Channel dissipation	P_{ch}^{*2}	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

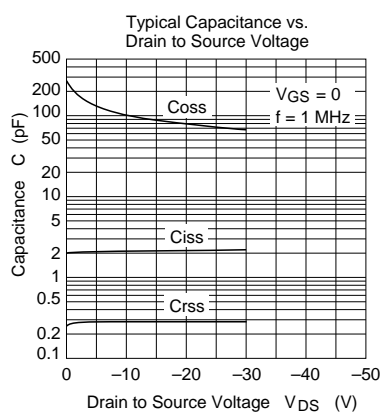
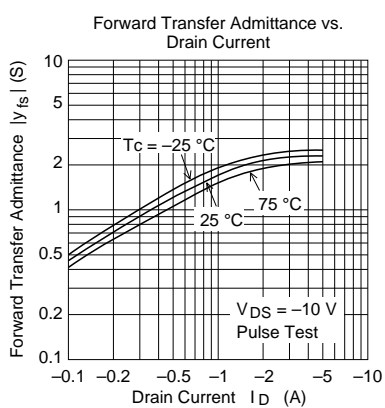
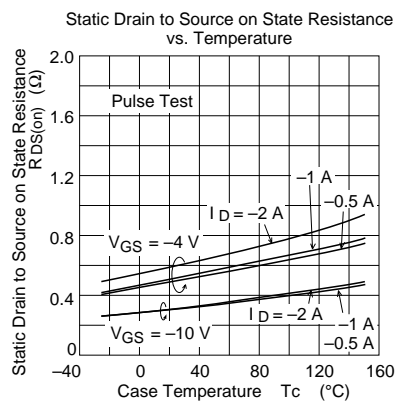
Notes 1. $PW \leq 100 \mu s$, duty cycle $\leq 10\%$
2. Value on the alumina ceramic board (12.5×20×0.7 mm)
3. Marking is "PY".

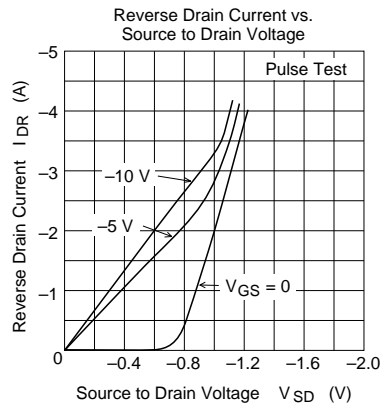
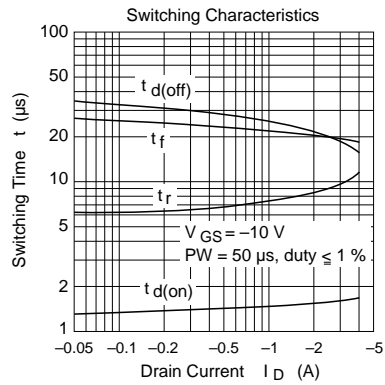
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	—	—	V	$I_D = -10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 10 \mu A$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	±5	μA	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-1	μA	$V_{DS} = -24 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	—	-2.0	V	$I_D = -100 \mu A$, $V_{DS} = -10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.6	0.75	Ω	$I_D = -1 \text{ A}$, $V_{GS} = -4 \text{ V}^{*1}$
		—	0.35	0.45	Ω	$I_D = -1 \text{ A}$, $V_{GS} = -10 \text{ V}^{*1}$
Forward transfer admittance	$ y_{fs} $	1.4	2.0	—	S	$I_D = -1 \text{ A}$, $V_{DS} = -10 \text{ V}^{*1}$
Input capacitance	Ciss	—	2.1	—	pF	$V_{DS} = -10 \text{ V}$, $V_{GS} = 0$, $f = 1 \text{ MHz}$
Output capacitance	Coss	—	100	—	pF	
Reverse transfer capacitance	Crss	—	0.25	—	pF	
Turn-on delay time	$t_{d(on)}$	—	1.65	—	μs	$I_D = -1 \text{ A}$, $V_{GS} = -10 \text{ V}$, $R_L = 30 \Omega$
Rise time	t_r	—	8	—	μs	
Turn-off delay time	$t_{d(off)}$	—	25.9	—	μs	
Fall time	t_f	—	14.9	—	μs	









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